Adjustable Precision Shunt Regulators

Product Description

The GS431 is a three-terminal adjustable shunt regulator with specified thermal stability.

The output voltage may be set to any value between V_{REF} and 36V with two external resistors.

This device has a typical output impedance of 0.2Ω . Active output circuitry provides very sharp turn-on characteristics, making this device excellent replacement for Zener diodes in many applications.

GS431 is available in SOT-23 package.

Features

- Temperature-Compensated for Operation over Full Rated Operating Temperature Range.
- Adjustable Output Voltage
- Low (0.2Ω Typ.) Dynamic Output Impedance
- Low Output Noise
- Fast Turn-on Response
- RoHS Compliant & Halogen Free

Applications

- Battery Operated Computer
- Switching Power Supplies
- Adjustable Power Supplies
- Linear Regulators
- Instrumentation
- Computer Disk Drivers

Typical Application

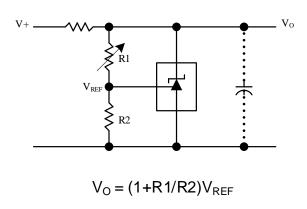


Figure 1. Shunt Regulator

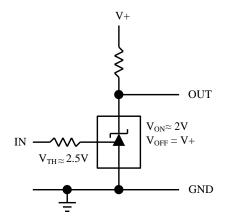


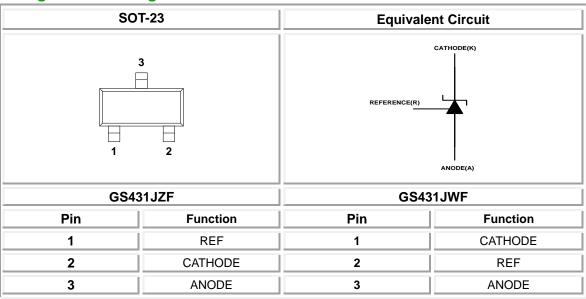
Figure 2. Single Supply Comparator with Temperature Compensated Threshold





-GS431

Packages & Pin Assignments



Ordering and Marking Information

Ordering Information				
Device	Package	Quantity/Reel		
GS431JZF	SOT-23	3000PCS		
GS431JWF	SOT-23	3000PCS		
GS431 11 11 F				
Product Code: GS431	Package Code: 1 1 is JZ and JW - Both are SOT-23 - Pin Assignment please refer to Pin Assignments section	Green Level: F stands for RoHS Compliant and Halogen Free		
	Marking Information			
412222				
Product Code: - 4	Pin Assignment: i is C or D C for GS431JWF D for GS431JZF	GS Code:		



Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)

Symbol	Parameter	Rating	Unit
VĸA	Cathode Voltage (Note 1)	37	V
lκ	Continuous Cathode Current Range	-10 to +150	mA
I _{REF}	Reference Current Range	-50µA to 10mA	mA
PD	Power Dissipation	0.23	W
T _{OPR}	Operating Temperature Range	-40 to 125	°C
TJ	Junction Temperature	+150	∘C
T_{STG}	Storage Temperature Range	-65 to 150	°C
T_{LEAD}	Lead Temperature Range(Soldering, 10sec)	260	°C

Note 1: Voltage values are with respect to the anode terminal unless otherwise noted.

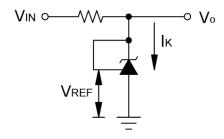
Electrical Characteristics

Electrical Characteristics at 25°C free-air temperature (unless otherwise noted).

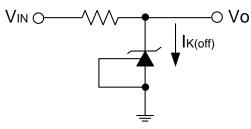
Symbol	Parameter		GS431			
		Conditions	Min	Тур	Max	Units
V _{REF}	Reference Voltage	VKA=VREF, IK=10mA	2.483	2.495	2.507	V
V _{DEV}	Deviation of reference input voltage over full temperature range	$V_{KA}=V_{REF}$, $I_{K}=10mA$, $T_{A}=Full\ range$ (Test circuit 1)		6.0	16	mV
	Ratio of change in reference input voltage to the change in cathode voltage	I _K =10mA, \triangle V _{KA} =10V to V _{REF} \triangle V _{KA} =36V to 10V	-2.7 -2	-1.4 -1		mV/V
I _{REF}	Reference input current	I _K =10mA, R1=10KΩ, R2=∞ (Test circuit 2)		1	4.0	μA
IREF (DEV)	Deviation of reference input current over full temperature range	I _K =10mA, R1=10KΩ, R2=∞, T _A = Full range (Test circuit 2)		0.4	1.2	μА
lĸ (min)	Minimum cathode current for regulation	V _{KA} = V _{REF} (Test circuit 1)		0.4	1.0	mA
lκ (off)	Off-state cathode current	V _{KA} =36V, V _{REF} =0 (Test circuit 3)		0.1	1.0	μA
Z _{KA}	Dynamic impedance	$f < 1KHz$, $V_{KA} = V_{REF}$ $I_K = 1mA$ to $100mA$		0.2	0.5	Ω



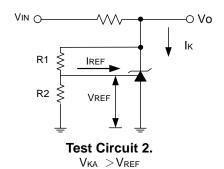
Test Circuits



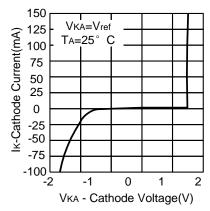
Test Circuit 1. $V_{KA}=V_{REF}$



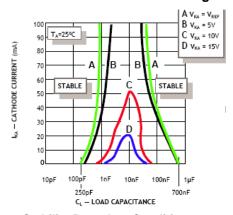
Test Circuit 3. Off-State Current



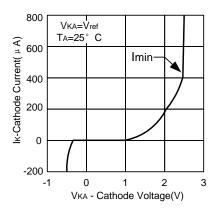
Typical Performance Characteristics



Cathode current vs. cathode voltage



Stability Boundary Conditions

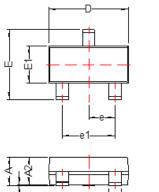


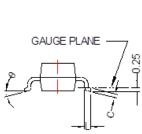
Cathode current vs. cathode voltage

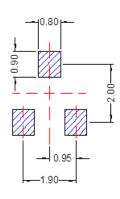
SOT-23

Package Dimension

Recommended Land Pattern







	Dimensions			
CVMDOL	Millin	neters	Inches	
SYMBOL	MIN	MAX	MIN	MAX
Α	0.75	1.17	0.030	0.046
A 1	0.01	0.15	0.000	0.006
A2	0.70	1.02	0.028	0.040
b	0.30	0.50	0.012	0.020
С	0.08	0.20	0.003	0.008
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E1	1.20	1.40	0.047	0.055
е	0.95 BSC 0.037 BSC		7 BSC	
e1	1.90 BSC		0.075 BSC	
L	0.3	0.6	0.012	0.024
θ	0 °	8°	0 °	8°

NOTE:

Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



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